

P-Channel 40-V (D-S), 175 °C MOSFET

PRODUCT SUMMARY

V_{DS} (V)	$r_{DS(on)}$ (Ω)	I_D (A) ^a	Q_g (Typ)
- 40	0.023 at $V_{GS} = 10$ V	- 20	20.6 nC
	0.030 at $V_{GS} = 4.5$ V	- 20	

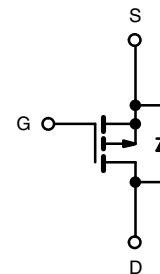
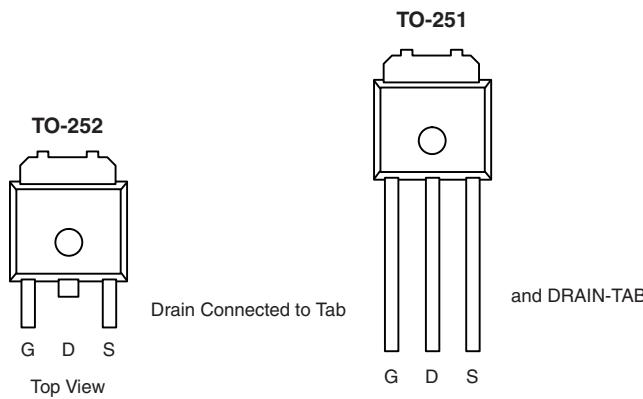
FEATURES

- TrenchFET® Power MOSFET
- 100 % R_g Tested



APPLICATIONS

- LCD TV Inverter



P-Channel MOSFET

Order Number:

SUD50P04-23-E3 (Lead (Pb)-free)

Order Number:

SUU50P04-23-E3 (Lead (Pb)-free)

ABSOLUTE MAXIMUM RATINGS $T_A = 25$ °C, unless otherwise noted

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	- 40	V
Gate-Source Voltage	V_{GS}	± 16	
Continuous Drain Current ($T_J = 150$ °C)	I_D	- 20 ^a	A
		- 20 ^a	
		- 8.2 ^b	
		- 5.7 ^b	
Pulsed Drain Current	I_{DM}	- 50	
Continuous Source-Drain Diode Current	I_S	- 20 ^a	A
		- 2.5 ^b	
Single Pulse Avalanche Current	I_{AS}	- 20	
Avalanche Energy	E_{AS}	20	mJ
Maximum Power Dissipation	P_D	45.4	W
		22.7	
		3.1 ^b	
		1.5 ^b	
Operating Junction and Storage Temperature Range	T_J, T_{stg}	- 55 to 175	°C

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^b	R_{thJA}	40	48	°C/W
Maximum Junction-to-Case	R_{thJC}	2.75	3.3	

Notes:

a. Package limited.

b. Surface mounted on 1" x 1" FR4 board.

SPECIFICATIONS $T_J = 25^\circ\text{C}$, unless otherwise noted

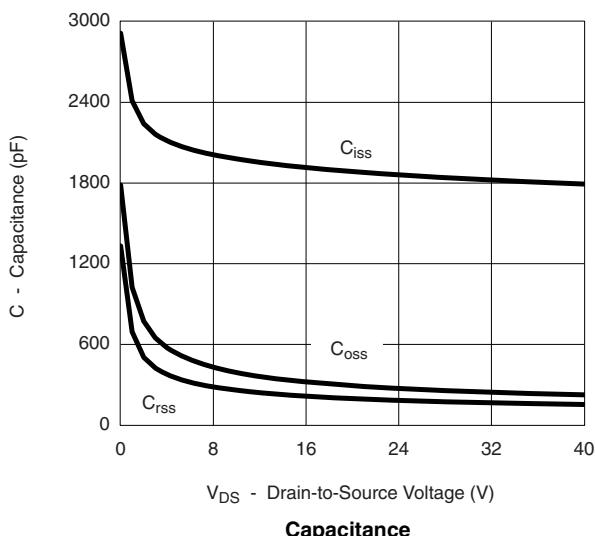
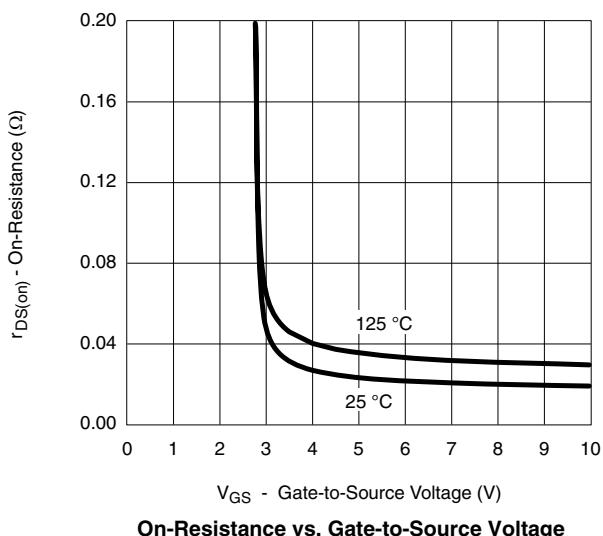
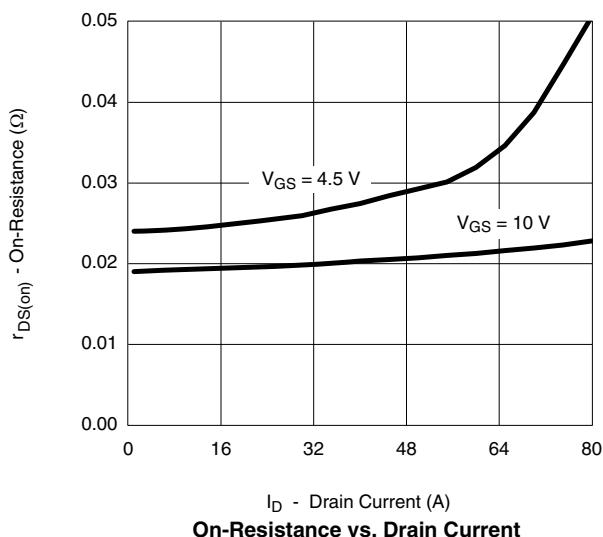
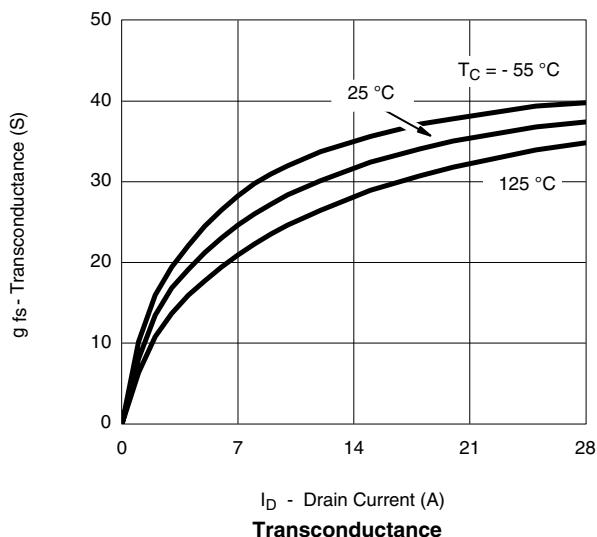
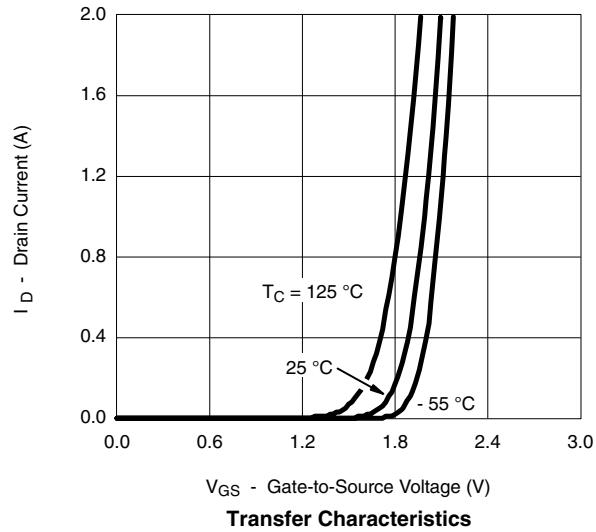
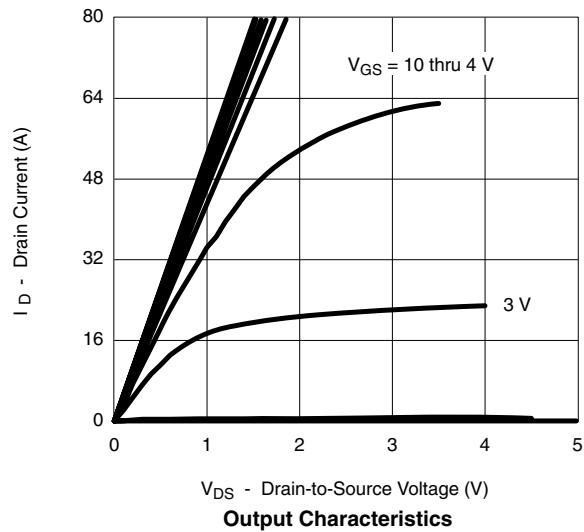
Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Static						
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-40			V
V_{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	$I_D = -250 \mu\text{A}$		-40		mV/ $^\circ\text{C}$
$V_{GS(\text{th})}$ Temperature Coefficient	$\Delta V_{GS(\text{th})}/T_J$			3.7		
Gate-Source Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = -250 \mu\text{A}$	-0.8		-2	V
Gate-Source Leakage	I_{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 16 \text{ V}$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = -40 \text{ V}, V_{GS} = 0 \text{ V}$			-1	μA
		$V_{DS} = -40 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 100^\circ\text{C}$			-20	
On-State Drain Current ^a	$I_{D(\text{on})}$	$V_{DS} \geq -5 \text{ V}, V_{GS} = -10 \text{ V}$	-30			A
Drain-Source On-State Resistance ^a	$r_{DS(\text{on})}$	$V_{GS} = -10 \text{ V}, I_D = -15 \text{ A}$		0.019	0.023	Ω
		$V_{GS} = -4.5 \text{ V}, I_D = -10 \text{ A}$		0.024	0.030	
Forward Transconductance ^a	g_{fs}	$V_{DS} = 15 \text{ V}, I_D = -15 \text{ A}$		30		S
Dynamic^b						
Input Capacitance	C_{iss}	$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		1880		pF
Output Capacitance	C_{oss}			286		
Reverse Transfer Capacitance	C_{rss}			192		
Total Gate Charge	Q_g	$V_{DS} = -20 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -30 \text{ A}$		43.5	65	nC
Gate-Source Charge	Q_{gs}			20.6	31	
Gate-Drain Charge	Q_{gd}			4.6		
Gate Resistance	R_g		$f = 1 \text{ MHz}$	7.6		
Turn-On Delay Time	$t_{d(\text{on})}$	$V_{DD} = -20 \text{ V}, R_L = 0.66 \Omega$ $I_D \geq -30 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$		3	5	Ω
Rise Time	t_r			22	35	ns
Turn-Off Delay Time	$t_{d(\text{off})}$			217	325	
Fall Time	t_f			42	65	
Turn-On Delay Time	$t_{d(\text{on})}$			21	32	
Rise Time	t_r	$V_{DD} = -20 \text{ V}, R_L = 0.66 \Omega$ $I_D \geq -30 \text{ A}, V_{GEN} = -10 \text{ V}, R_g = 1 \Omega$		8	15	ns
Turn-Off Delay Time	$t_{d(\text{off})}$			12	20	
Fall Time	t_f			36	55	
				9	15	
Drain-Source Body Diode Characteristics						
Continuous Source-Drain Diode Current	I_S	$T_C = 25^\circ\text{C}$			-20	A
Pulse Diode Forward Current ^a	I_{SM}				-50	
Body Diode Voltage	V_{SD}	$I_S = -10 \text{ A}$		-0.85	-1.2	V
Body Diode Reverse Recovery Time	t_{rr}	$I_F = -20 \text{ A}, di/dt = 100 \text{ A}/\mu\text{s}, T_J = 25^\circ\text{C}$		44	66	ns
Body Diode Reverse Recovery Charge	Q_{rr}			53	80	nC
Reverse Recovery Fall Time	t_a			18		ns
Reverse Recovery Rise Time	t_b			26		

Notes:

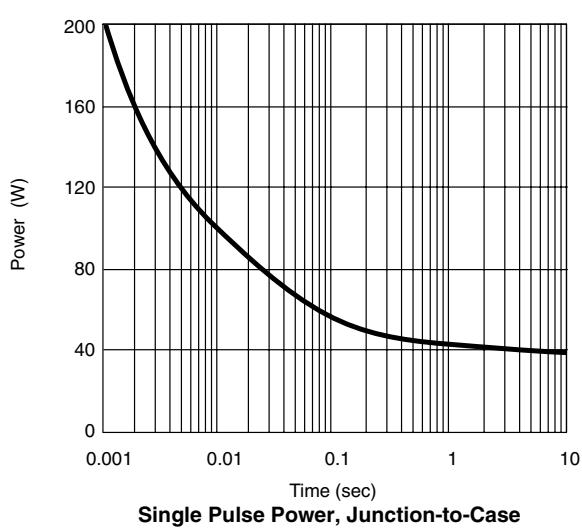
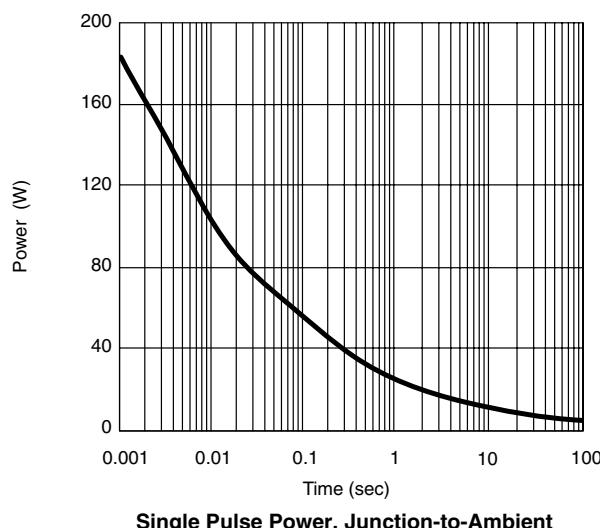
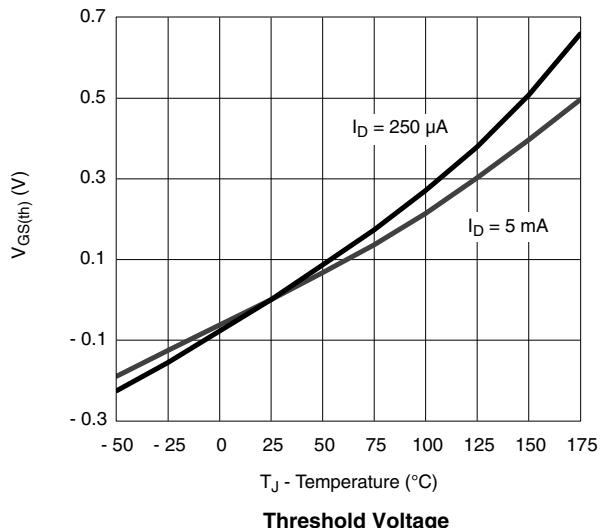
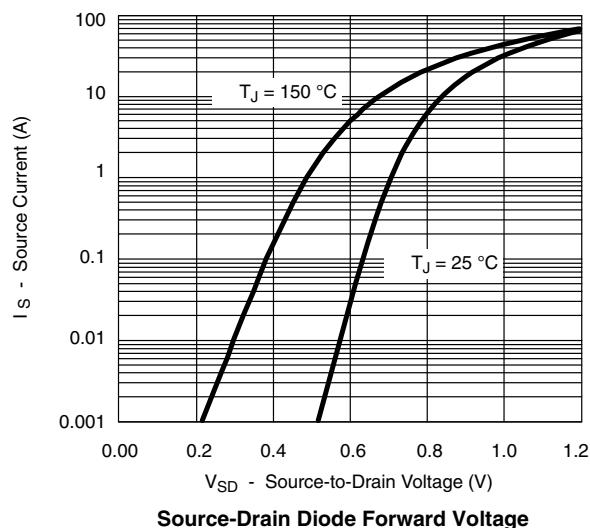
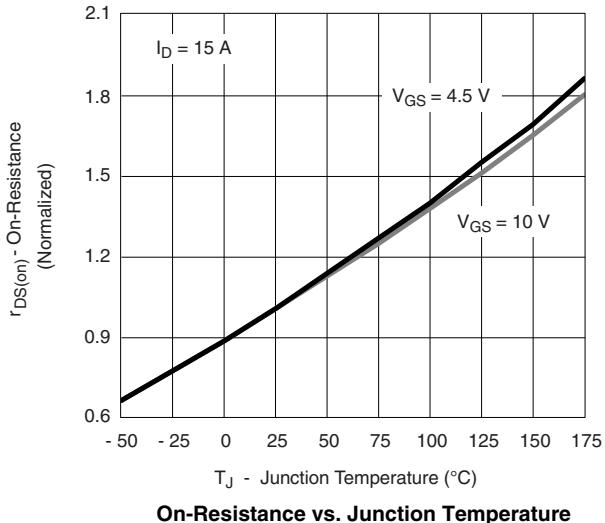
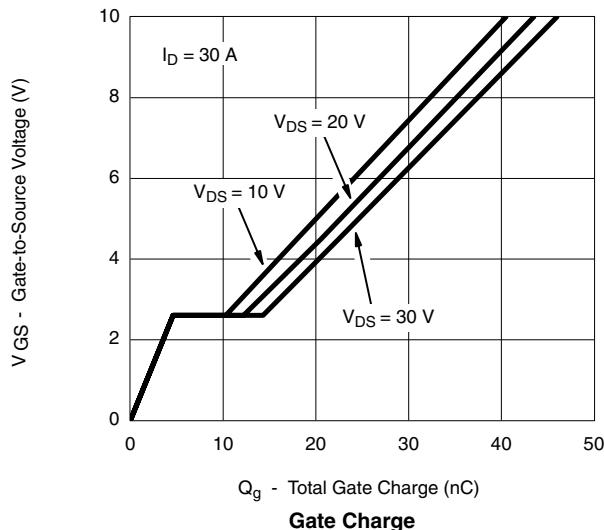
a. Pulse test; pulse width $\leq 300 \mu\text{s}$, duty cycle $\leq 2\%$.

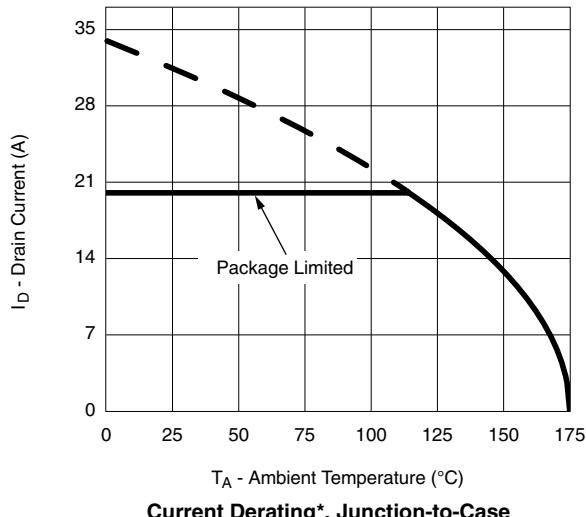
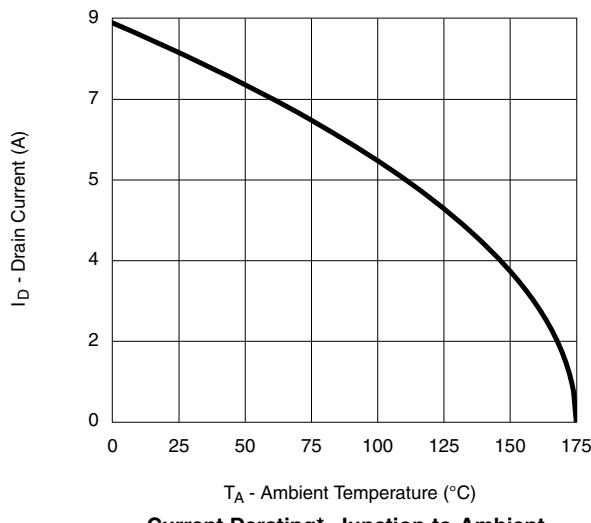
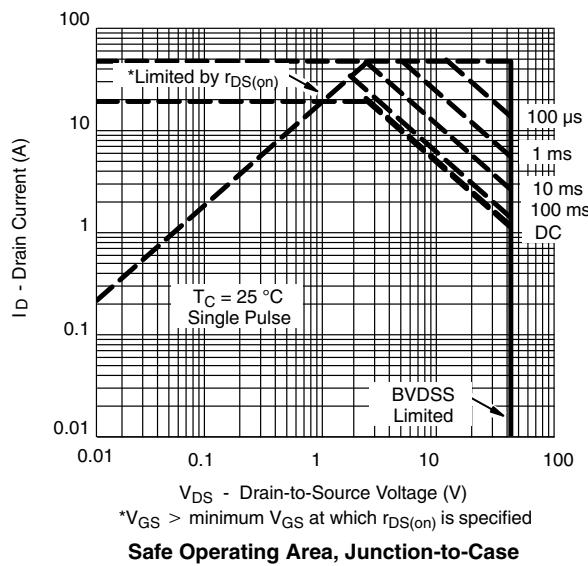
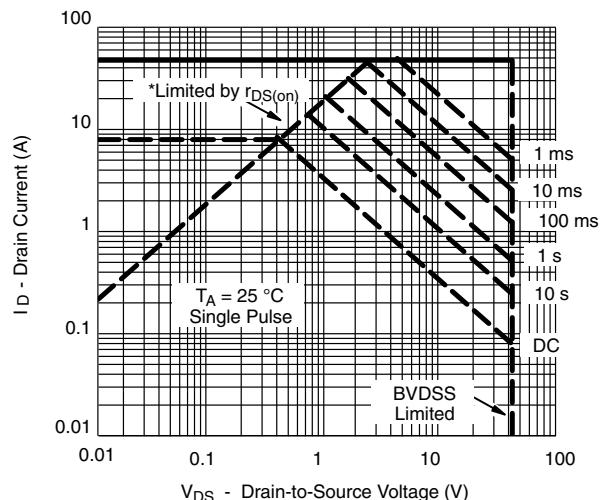
b. Guaranteed by design, not subject to production testing.

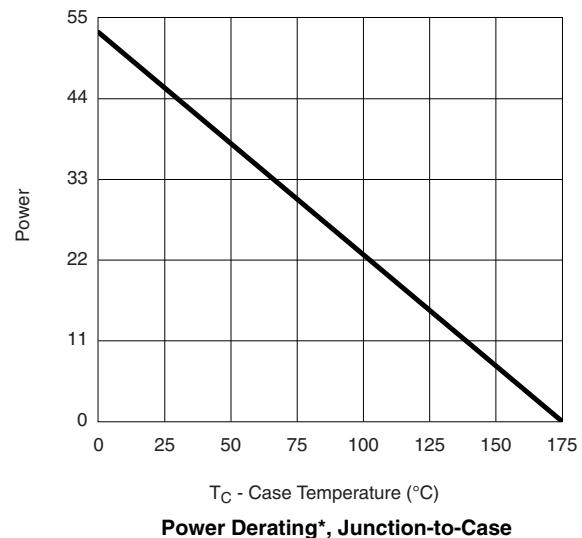
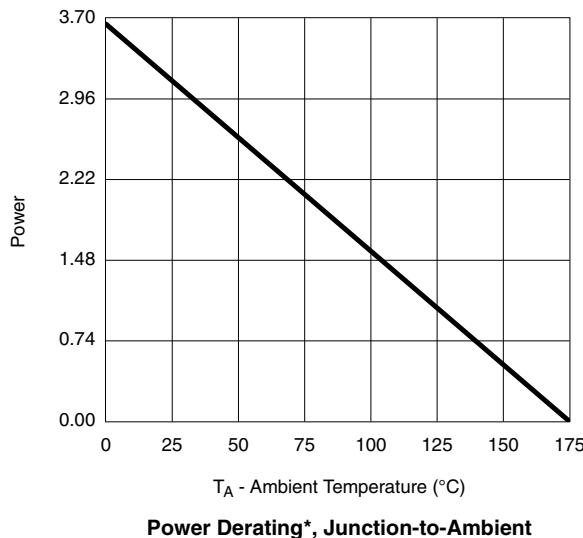
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted


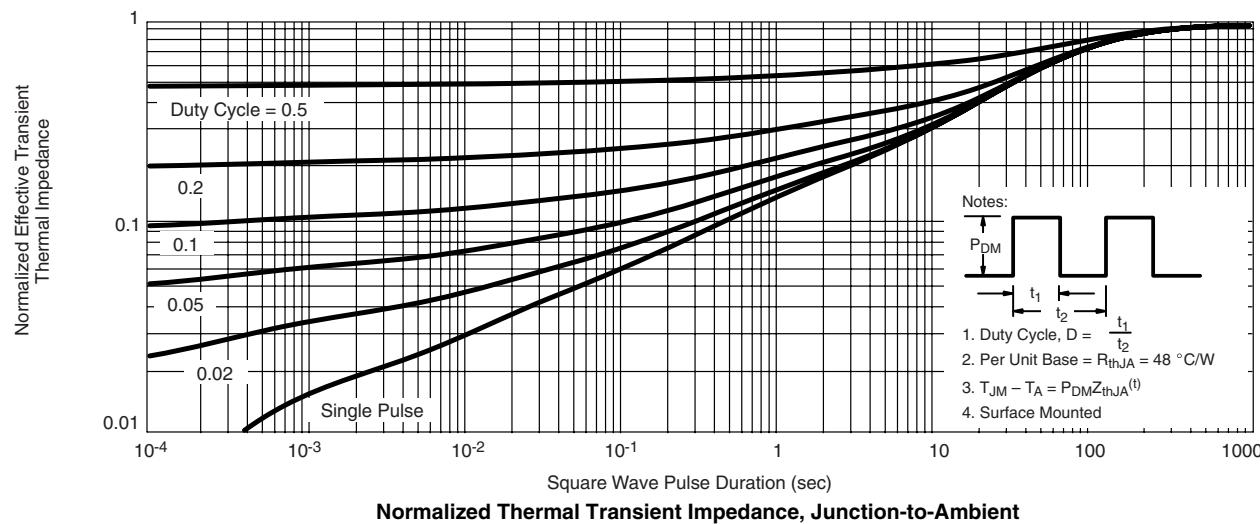
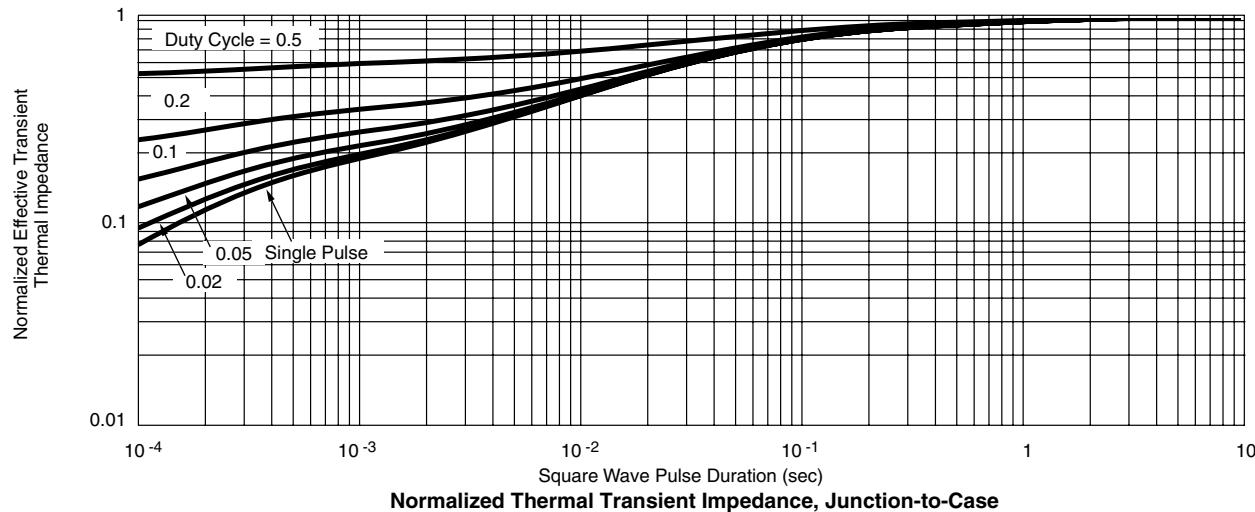
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

*The power dissipation P_D is based on $T_{J(\max)} = 175$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

Normalized Thermal Transient Impedance, Junction-to-Ambient

Normalized Thermal Transient Impedance, Junction-to-Case

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